KOREA 2021

DISCOVERY SUMMIT

EXPLORING DATA INSPIRING INNOVATION



JMP를 활용한 공정 이상점 파악 및 수율 개선



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- Introduce
 - About Optical Solution business
 - What is the 3D sensing module?
- Case In Using JMP
 - Understanding abnormal process
 - Improving yield
- Lesson and Learn





About Optical Solution business



- Manufacturing optical components in mobilephones
- : camera module 3D sensing module

- Various processes and machines in manufacturing line
- : Quick understanding of abnormal feature between processes and equipment

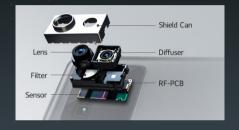




What is the 3D sensing module?



LiDAR: ToF(Time of Flight) sensing module





Face ID: Structured Light sensing module

Providing professional-class camera quality for mobile-phones and providing virtual reality space construction functions





CASE In Using JMP

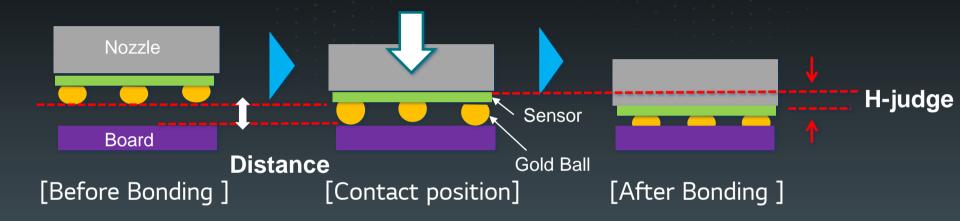


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Case.1 abnormal sensor bonding position

Using JMP at bonding process - #Graph Builder



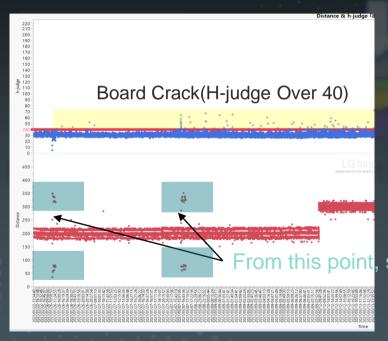
H-judge > 40, Board is cracked. We monitored and analyzed machine log





Case.1 abnormal sensor bonding position

Using JMP at bonding process - #Graph Builder



H-judge value Outlier Found that the cause is a Distance outlier. Can be caused by material strain

Easily find process abnomal point with MP

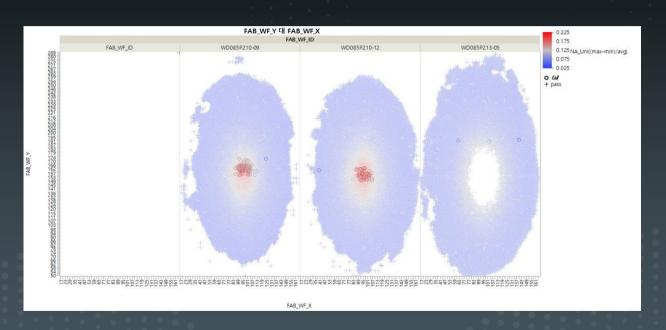
From this point, substrate cracks began to increase.





Case.2 Improving yield – notice raw material

Using JMP at bonding process - #Graph Builder, Data Concatenate



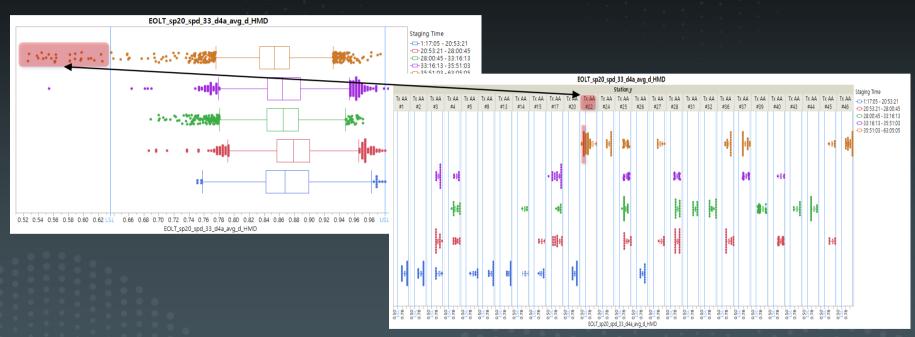
Shows a tendency for defective modules(RED) to appear in the center of the wafer





Case.3 Improving yield – notice machine problem

Using JMP at bonding process - #Graph Builder, Data Concatenate



It can be seen that defects occur specifically in the para in a specific facility.





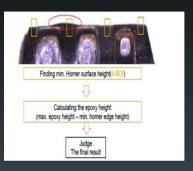
Case.4 Correlation parameter with JMP

Using JMP at Vision machine-#Graph Builder, Gauge R&R, Linear Fit



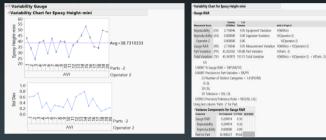
VS.

Measuring Instrument (Nexiv)



Vision machine (measuring height)

1. Gage RnR



2. Correlation



JMP Can be used for verification of comparing measuring instrument and Vision machine.







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1. Speed

2. Easy

3. Visible





1. Speed

2. Easy

3. Visible

◆ Analysis is fast

Many parameters and large files can be analyzed.





1. Speed

2. Easy

3. Visible

◆ Click and drop, can get graph

Many parameters and large files can be graphed easily





1. Speed

2. Easy

3. Visible

Easy to visually identify problems about machine





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